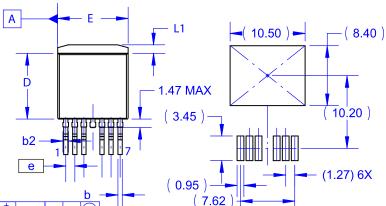
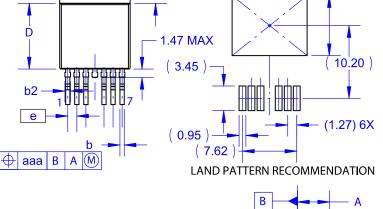
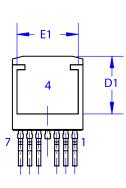


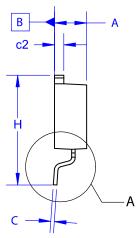
D2PAK7 (TO-263 7 LD) CASE 418AY ISSUE C

DATE 15 JUL 2019









NOTES:

A. PACKAGE CONFORMS TO JEDEC TO-263 VARIATION CB EXCEPT WHERE NOTED. B. ALL DIMENSIONS ARE IN MILLIMETERS.

OUT OF JEDEC STANDARD VALUE.
D. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
E. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
F. LAND PATTERN RECOMMENDATION PER IPC. TO127P1524X465-8N.

DIM	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	4.30	4.50	4.70	
A 1	0.00	0.10	0.20	
b2	0.70	0.80	0.90	
b	0.50	0.60	0.70	
С	0.40	0.50	0.60	
c2	1.20	1.30	1.40	
D	9.00	9.20	9.40	
D1	7.70	~	~	
Е	9.70	9.90	10.20	
E1	8.38	8.58	8.78	
е	~	1.27	~	
Ι	15.10	15.40	15.70	
L	2.44	2.64	2.84	
L1	1.00	1.20	1.40	
L3	~	0.25	~	
aaa	~	~	0.25	

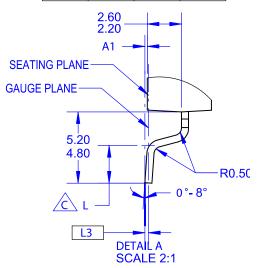
GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code = Assembly Location

= Year WW = Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.



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